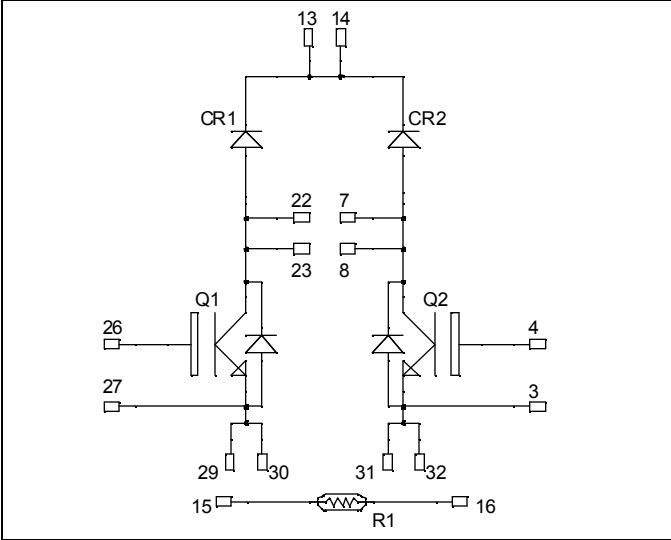


**Dual Boost chopper
PT IGBT Power Module**

**$V_{CES} = 1200V$
 $I_C = 30A @ T_c = 80^\circ C$**

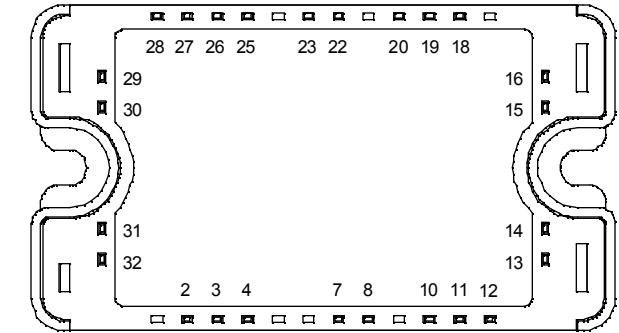


Application

- AC and DC motor control
- Switched Mode Power Supplies
- Power Factor Correction

Features

- Power MOS 7[®] Punch Through (PT) IGBT
 - Low conduction loss
 - Ultra fast tail current shutoff
 - Low gate charge
 - Switching frequency capability in the 200kHz range
 - Soft recovery parallel diodes
 - Low diode VF
- Kelvin emitter for easy drive
- Very low stray inductance
 - Symmetrical design
- Internal thermistor for temperature monitoring
- High level of integration



Benefits

- Outstanding performance at high frequency operation
- Direct mounting to heatsink (isolated package)
- Low junction to case thermal resistance
- Solderable terminals both for power and signal for easy PCB mounting
- Low profile
- Each leg can be easily paralleled to achieve a single boost of twice the current capability.

All multiple inputs and outputs must be shorted together
Example: 13/14 ; 29/30 ; 22/23 ...

Absolute maximum ratings

Symbol	Parameter	Max ratings	Unit
V_{CES}	Collector - Emitter Breakdown Voltage	1200	V
I_C	Continuous Collector Current	$T_c = 25^\circ C$	45
		$T_c = 80^\circ C$	30
I_{CM}	Pulsed Collector Current	$T_c = 25^\circ C$	105
V_{GE}	Gate - Emitter Voltage	± 20	V
P_D	Maximum Power Dissipation	$T_c = 25^\circ C$	208
RBSOA	Reverse Bias Safe Operating Area	$T_j = 150^\circ C$	105A @ 960V

CAUTION: These Devices are sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed.

All ratings @ $T_j = 25^\circ\text{C}$ unless otherwise specified

Electrical Characteristics

Symbol	Characteristic	Test Conditions	Min	Typ	Max	Unit
BV_{CES}	Collector - Emitter Breakdown Voltage	$V_{GE} = 0\text{V}$, $I_C = 250\mu\text{A}$	1200			V
I_{CES}	Zero Gate Voltage Collector Current	$V_{GE} = 0\text{V}$			250	μA
		$V_{CE} = 1200\text{V}$			2500	
$V_{CE(on)}$	Collector Emitter on Voltage	$V_{GE} = 15\text{V}$		3.3	3.9	V
		$I_C = 30\text{A}$		3.0		
$V_{GE(th)}$	Gate Threshold Voltage	$V_{GE} = V_{CE}$, $I_C = 1\text{mA}$	3		6	V
I_{GES}	Gate - Emitter Leakage Current	$V_{GE} = \pm 20\text{V}$, $V_{CE} = 0\text{V}$			± 100	nA

Dynamic Characteristics

Symbol	Characteristic	Test Conditions	Min	Typ	Max	Unit	
C_{ies}	Input Capacitance	$V_{GE} = 0\text{V}$		3240		pF	
C_{oes}	Output Capacitance	$V_{CE} = 25\text{V}$		248			
C_{res}	Reverse Transfer Capacitance	$f = 1\text{MHz}$		31			
Q_g	Total gate charge	$V_{GE} = 15\text{V}$		150		nC	
Q_{ge}	Gate - Emitter Charge	$V_{Bus} = 600\text{V}$		21			
Q_{gc}	Gate - Collector Charge	$I_C = 30\text{A}$		62			
$T_{d(on)}$	Turn-on Delay Time	Inductive Switching (25°C) $V_{GE} = 15\text{V}$ $V_{Bus} = 600\text{V}$ $I_C = 30\text{A}$ $R_G = 5\Omega$		16		ns	
T_r	Rise Time			20			
$T_{d(off)}$	Turn-off Delay Time			94			
T_f	Fall Time			40			
E_{on1}	Turn-on Switching Energy				750		μJ
E_{on2}	Turn-on Switching Energy ①				1305		
E_{off}	Turn-off Switching Energy ②				680		
$T_{d(on)}$	Turn-on Delay Time		Inductive Switching (125°C) $V_{GE} = 15\text{V}$ $V_{Bus} = 600\text{V}$ $I_C = 30\text{A}$ $R_G = 5\Omega$		16		ns
T_r	Rise Time			20			
$T_{d(off)}$	Turn-off Delay Time			147			
T_f	Fall Time			75			
E_{on1}	Turn-on Switching Energy				750		μJ
E_{on2}	Turn-on Switching Energy ①				2132		
E_{off}	Turn-off Switching Energy ②				1744		

① E_{on2} includes diode reverse recovery

② In accordance with JEDEC standard JESD24-1

Temperature sensor NTC

Symbol	Characteristic	Min	Typ	Max	Unit
R_{25}	Resistance @ 25°C		68		$\text{k}\Omega$
$B_{25/85}$	$T_{25} = 298.16\text{K}$		4080		K

$$R_T = \frac{R_{25}}{\exp\left[B_{25/85}\left(\frac{1}{T_{25}} - \frac{1}{T}\right)\right]}$$

T: Thermistor temperature
 R_T : Thermistor value at T

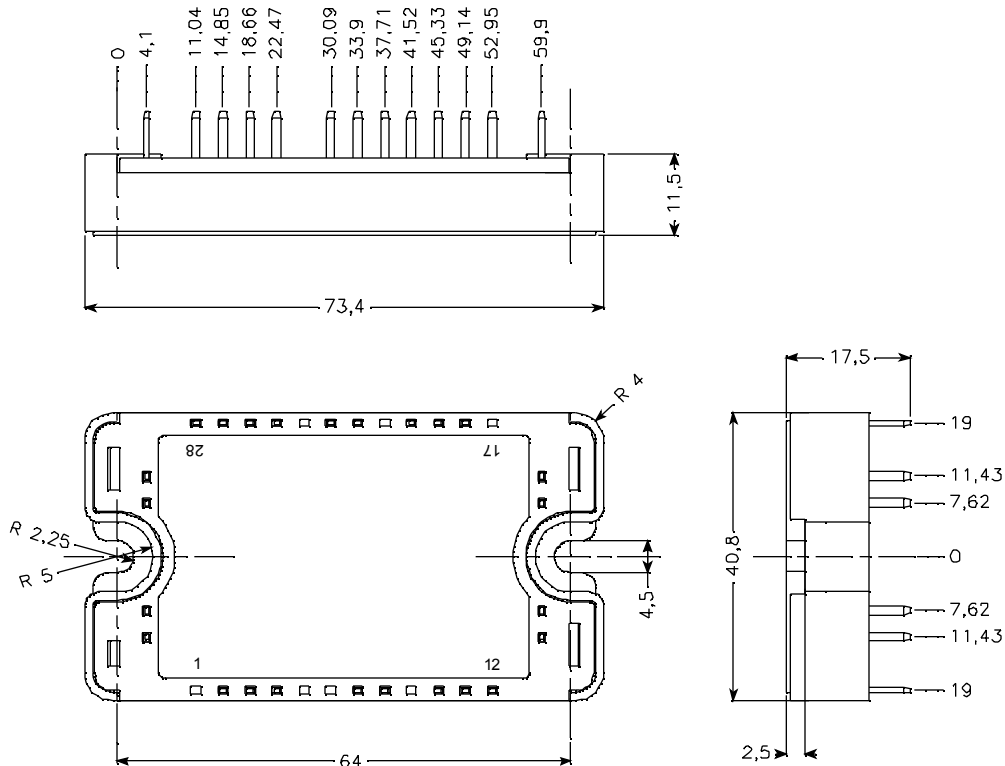
Diode ratings and characteristics

Symbol	Characteristic	Test Conditions		Min	Typ	Max	Unit
V _{RRM}	Maximum Peak Repetitive Reverse Voltage			1200			V
I _{RM}	Maximum Reverse Leakage Current	V _R =1200V	T _j = 25°C			250	µA
			T _j = 125°C			500	
I _{F(AV)}	Maximum Average Forward Current	50% duty cycle	T _c = 70°C		60		A
V _F	Diode Forward Voltage	I _F = 60A			2	2.5	V
		I _F = 120A			2.3		
		I _F = 60A	T _j = 125°C		1.8		
t _{rr}	Reverse Recovery Time	I _F = 60A V _R = 800V di/dt = 200A/µs	T _j = 25°C		400		ns
			T _j = 125°C		470		
Q _{rr}	Reverse Recovery Charge		T _j = 25°C		1200		nC
			T _j = 125°C		4000		

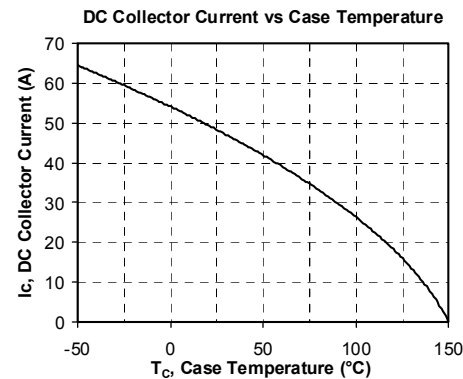
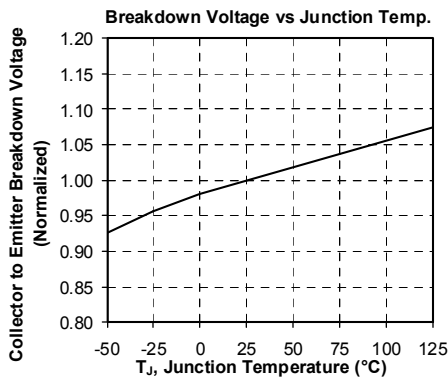
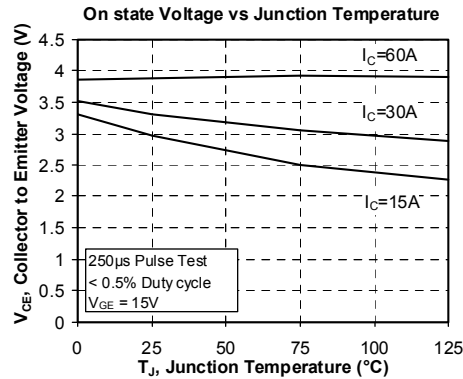
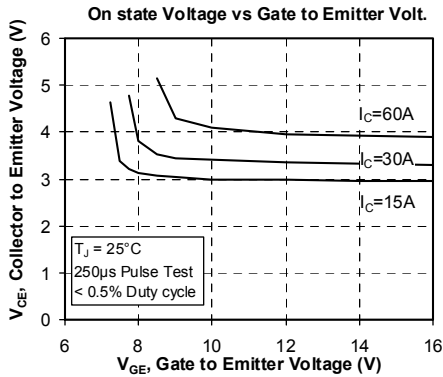
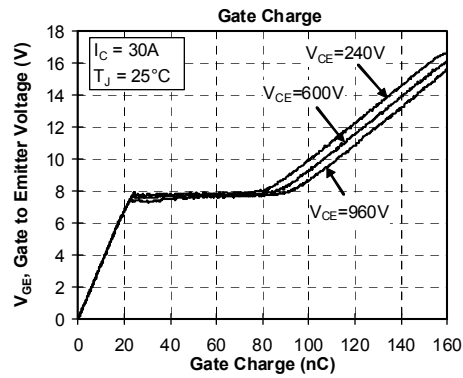
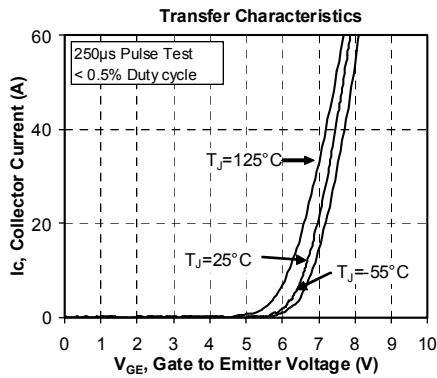
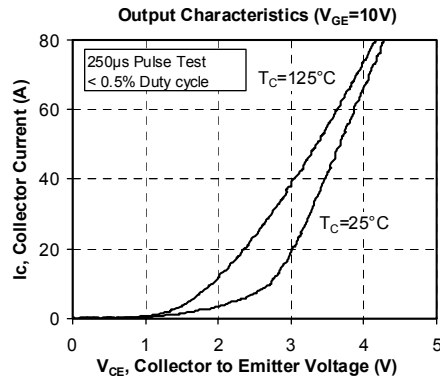
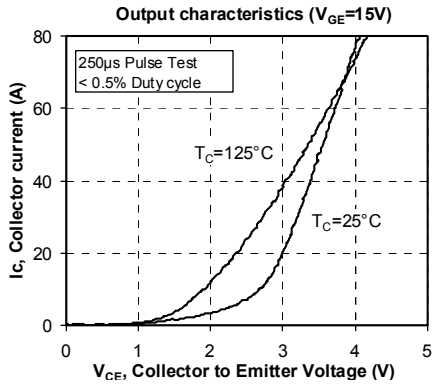
Thermal and package characteristics

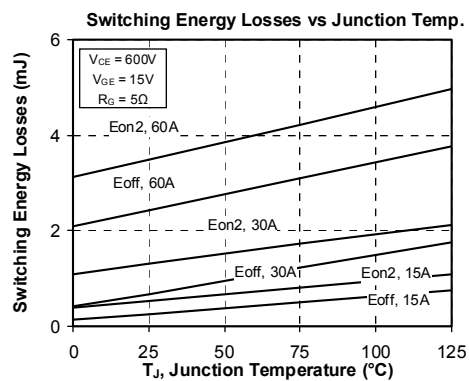
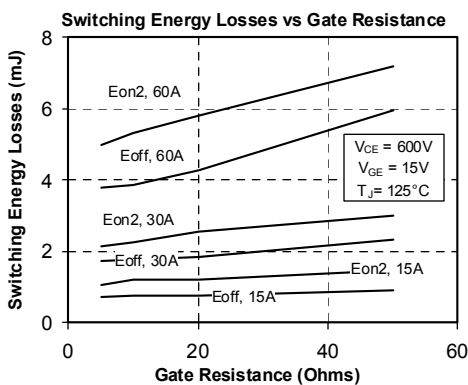
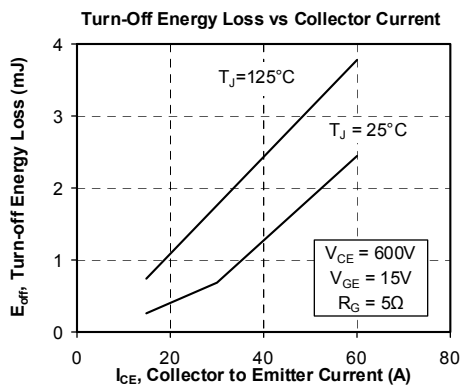
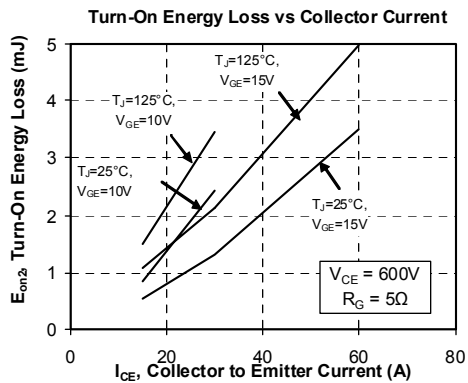
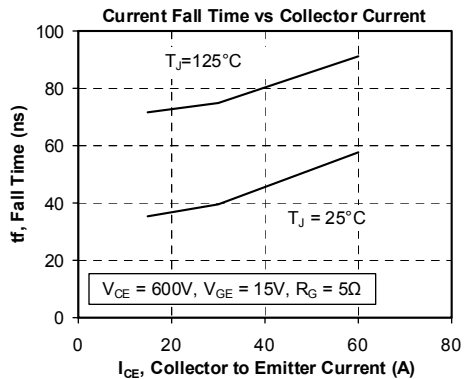
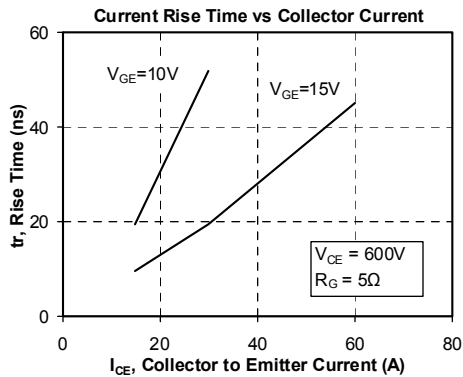
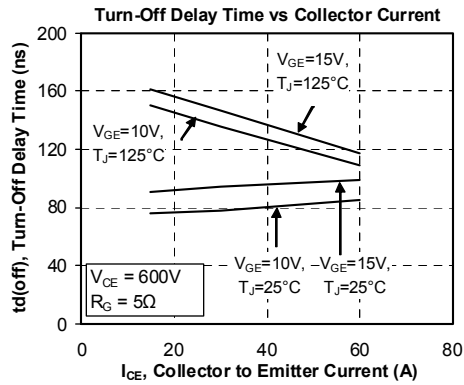
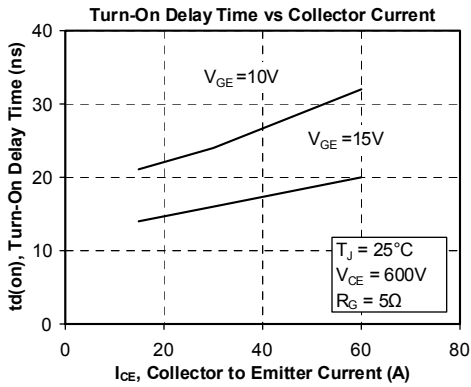
Symbol	Characteristic	Min	Typ	Max	Unit	
R _{thJC}	Junction to Case	IGBT		0.6	°C/W	
		Diode		0.9		
V _{ISOL}	RMS Isolation Voltage, any terminal to case t=1 min, I _{isol} <1mA, 50/60Hz	2500			V	
T _J	Operating junction temperature range	-40		150	°C	
T _{STG}	Storage Temperature Range	-40		125		
T _C	Operating Case Temperature	-40		100		
Torque	Mounting torque	To heatsink	M4		4.7	N.m
Wt	Package Weight				110	g

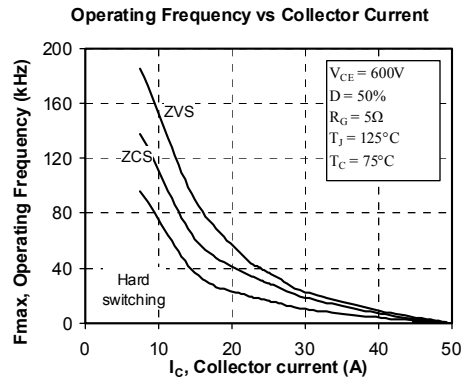
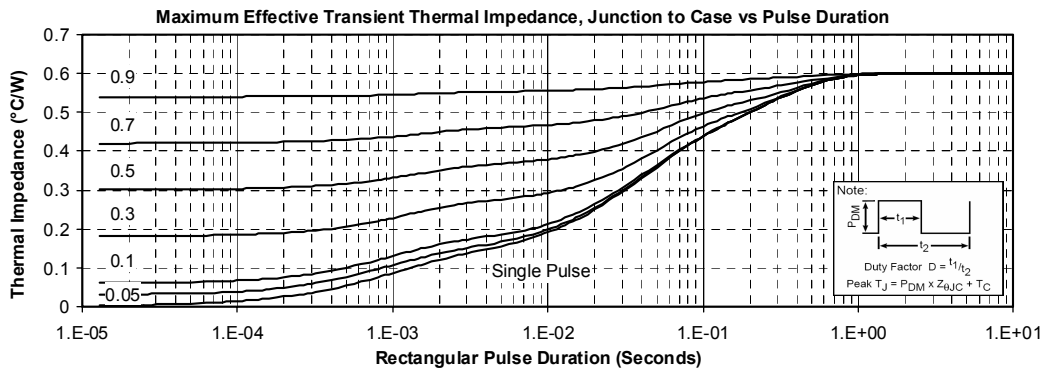
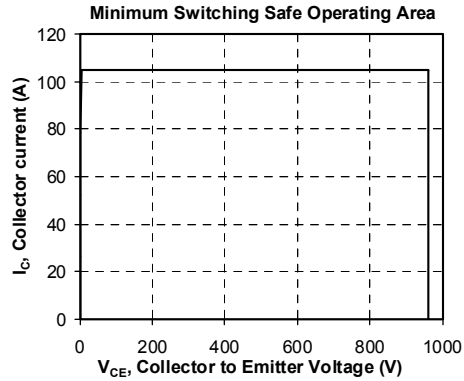
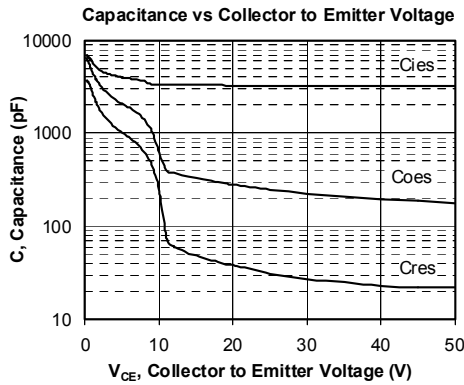
Package outline



Typical Performance Curve







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